



AiP74AC00

Quad 2-Input Nand Gate

Product Specification

Specification Revision History:

Version	Date	Description
2024-11-A0	2024-11	New
2025-03-A1	2025-03	Modify the parameters



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1、General Description

The AiP74AC00 is quad 2-input nand gate.

Features:

- Supply voltage range: 2V to 6V
- Input levels: CMOS level
- Temperature range: -40°C to +125°C
- Packaging information: DIP14/SOP14/TSSOP14

Ordering Information:

Tube packing specifications:

Part number	Packaging form	Marking code	Tube quantity	Boxed tube quantity	Boxed quantity	Notes
AiP74AC00DA14.TB	DIP14	74AC00	25 PCS/tube	40 tube/box	1000 PCS/box	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing: 2.54mm

Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
AiP74AC00SA14.TR	SOP14	74AC00	4000 PCS/reel	8000 PCS/box	Dimensions of plastic enclosure: 8.7mm×3.9mm Pin spacing: 1.27mm
AiP74AC00TA14.TR	TSSOP14	74AC00	5000 PCS/reel	10000 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm

Note: If the physical information is inconsistent with the ordering information, please refer to the actual product.



2、Block Diagram And Pin Description

2.1、Block Diagram



Figure 1. Logic symbol

2.2、Pin Configurations

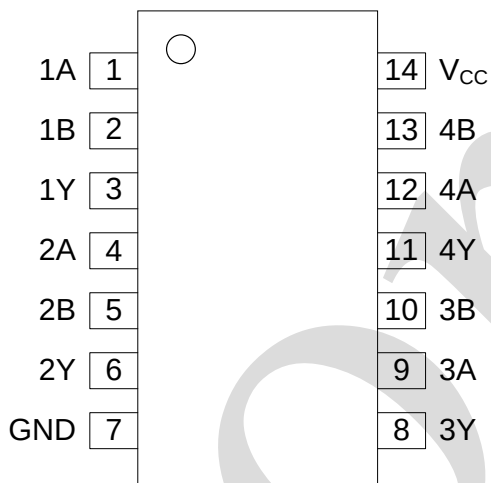


Figure 2. Pin configurations

2.3、Pin Description

Pin No.	Pin Name	Description
1	1A	data input
2	1B	data input
3	1Y	data output
4	2A	data input
5	2B	data input
6	2Y	data output
7	GND	ground (0V)
8	3Y	data output
9	3A	data input
10	3B	data input
11	4Y	data output
12	4A	data input
13	4B	data input
14	V _{CC}	supply voltage



2.4、Function Table

Input		Output
nA	nB	nY
H	H	L
L	X	H
X	L	H

Note: H=HIGH voltage level; L=LOW voltage level; X=Don't care.

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{CC}	-	-0.5	+7	V
continuous supply current	I_{CC}	-	-	200	mA
continuous ground current	I_{GND}	-	-200	-	mA
input clamping current	I_{IK}	$V_I < 0V$ or $V_I > V_{CC}$	-	± 20	mA
output clamping current	I_{OK}	$V_O < 0V$ or $V_O > V_{CC}$	-	± 20	mA
continuous output current	I_O	$V_O = 0$ to V_{CC}	-	± 50	mA
storage temperature	T_{stg}	-	-65	+150	$^{\circ}C$
soldering temperature	T_L	10s	DIP		245
			SOP/TSSOP		260

3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{CC}	-	2	-	6	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
High-level output current	I_{OH}	-	-	-	-24	mA
Low-level output current	I_{OL}	-	-	-	24	mA
ambient temperature	T_{amb}	-	-40	-	+125	$^{\circ}C$



3.3、Electrical Characteristics

3.3.1、DC Characteristics

($T_{amb}=-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V_{CC}	Conditions	Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	3V	-	2.1	-	-	V
		4.5V	-	3.15	-	-	V
		5.5V	-	3.85	-	-	V
LOW-level input voltage	V_{IL}	3V	-	-	-	0.9	V
		4.5V	-	-	-	1.35	V
		5.5V	-	-	-	1.65	V
HIGH-level output voltage	V_{OH}	3V	$I_O=-50\mu\text{A}$	2.9	-	-	V
			$I_O=-12\text{mA}$	2.46	-	-	V
		4.5V	$I_O=-50\mu\text{A}$	4.4	-	-	V
			$I_O=-24\text{mA}$	3.76	-	-	V
		5.5V	$I_O=-50\mu\text{A}$	5.4	-	-	V
			$I_O=-24\text{mA}$	4.76	-	-	V
LOW-level output voltage	V_{OL}	3V	$I_O=-50\mu\text{A}$	-	-	0.1	V
			$I_O=-12\text{mA}$	-	-	0.44	V
		4.5V	$I_O=50\mu\text{A}$	-	-	0.1	V
			$I_O=24\text{mA}$	-	-	0.44	V
		5.5V	$I_O=50\mu\text{A}$	-	-	0.1	V
			$I_O=24\text{mA}$	-	-	0.44	V
input leakage current	I_I	5.5V	$V_I=V_{CC}$ or GND	-	-	± 1	μA
supply current	I_{CC}	5.5V	$V_I=V_{CC}$ or GND; $I_O=0\text{A}$	-	-	20	μA

3.3.2、AC Characteristics

($T_{amb}=-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions		Min.	Typ.	Max.	Unit
A or B to Y propagation delay	t _{PLH}	3.3V	C _L =50pF R _L =500Ω	see Figure 4	2	7	12	ns
	t _{PHL}				1	5.5	10.2	ns
	t _{PLH}	5.5V			1.5	6	10.2	ns
	t _{PHL}				1.5	4.5	8.4	ns



4、Testing Circuit

4.1、AC Testing Circuit

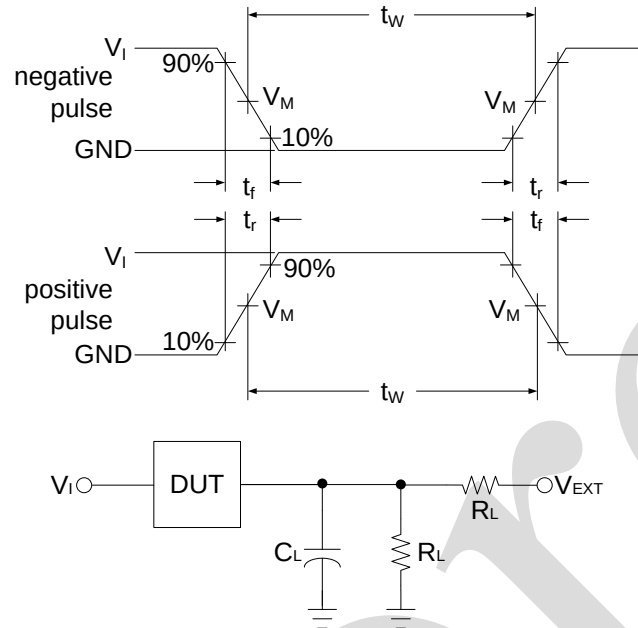


Figure 3. Test circuit for measuring switching times

C_L includes probe and jig capacitance.

4.2、Test Data

Input		Load		V_{EXT}		
V_I	$t_r = t_f$	C_L	R_L	t_{PLH}/t_{PHL}	t_{PLZ}/t_{PZL}	t_{PHZ}/t_{PZH}
V_{CC}	3.0ns	50pF	500 Ω	Open	$2 \times V_{CC}$	GND



4.3、AC Testing Waveforms

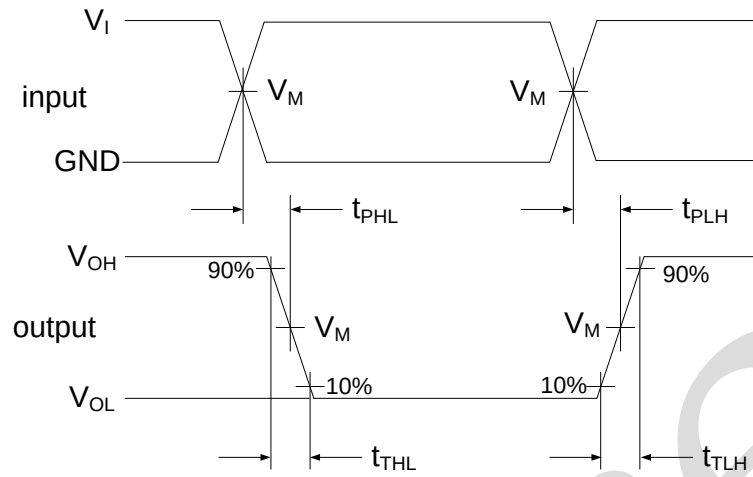


Figure 4. The data input (A) to output (Y) propagation delays

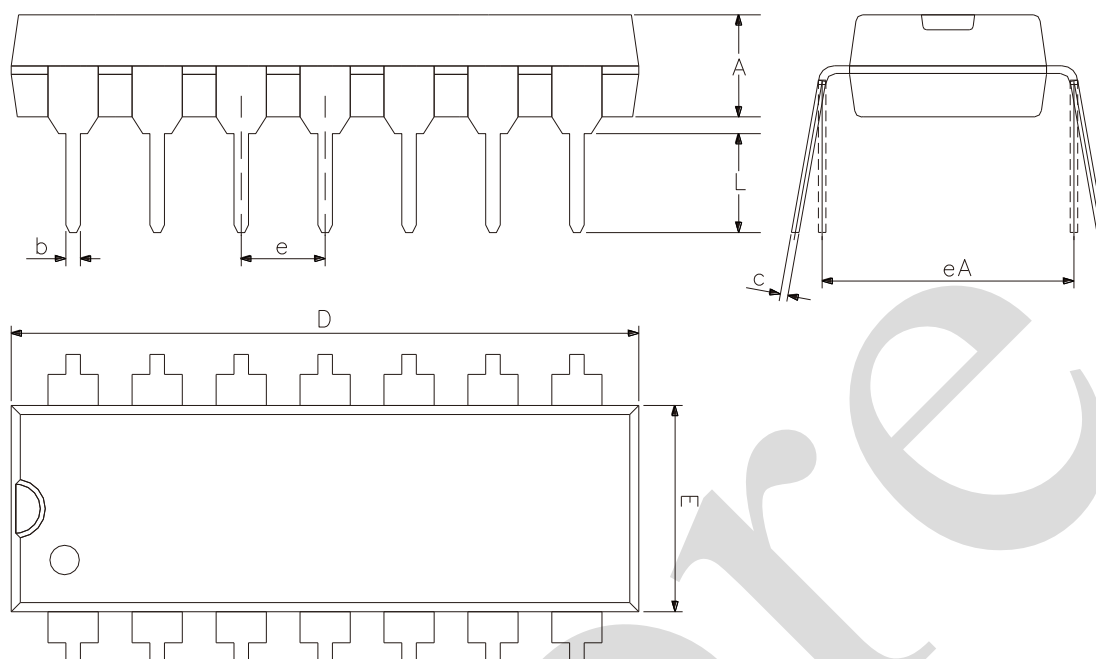
4.4、Measurement Points

Input	Output
V_M	V_M
$0.5 \times V_{CC}$	$0.5 \times V_{CC}$



5、Package Information

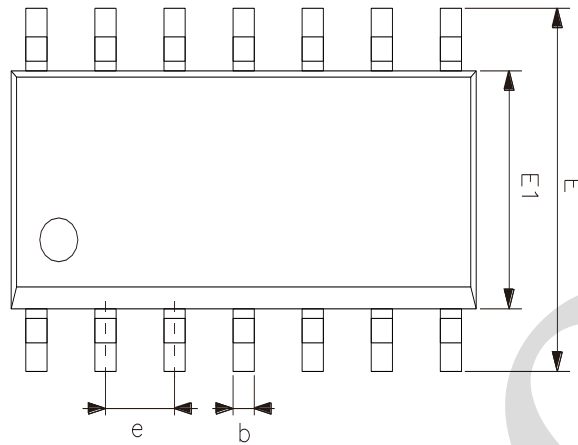
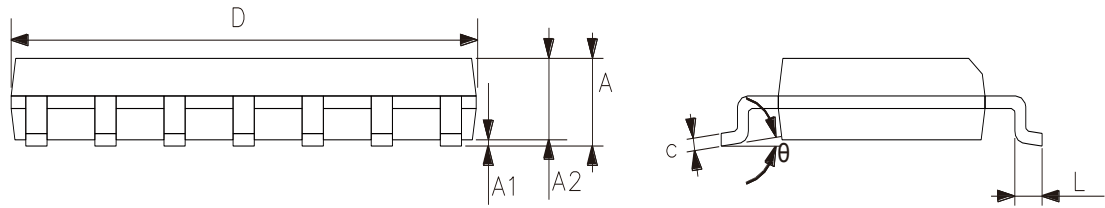
5.1、DIP14



2023/12/A	Dimensions In Millimeters	
Symbol	Min	Max
A	3.05	3.60
b	0.33	0.56
c	0.20	0.36
D	18.80	19.40
E	6.20	6.60
e	2.54	
eA	7.62	10.90
L	2.92	—



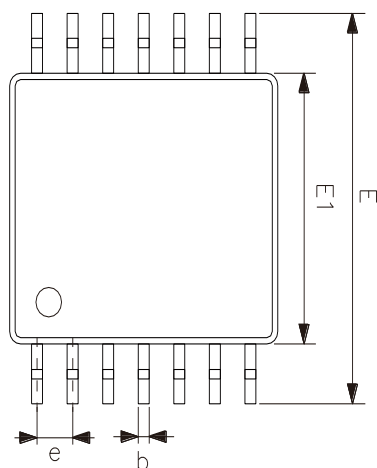
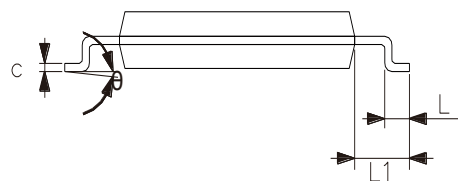
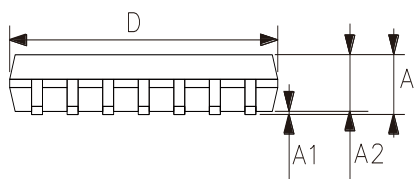
5.2、SOP14



2023/12/A	Dimensions In Millimeters	
Symbol	Min.	Max.
A	1.50	1.75
A1	0.05	0.25
A2	1.30	—
b	0.33	0.50
c	0.19	0.25
D	8.43	8.76
E	5.80	6.25
E1	3.75	4.00
e	1.27	
L	0.40	0.89
θ	0°	8°



5.3、TSSOP14



2023/12/A	Dimensions In Millimeters	
Symbol	Min	Max
A	—	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	4.90	5.10
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
L1	1.00	
θ	0°	8°



6、Statements And Notes

6.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、Notes

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